

Sonda de prueba de fuerza de resorte de 200 g para prueba de PCB

Información del Producto

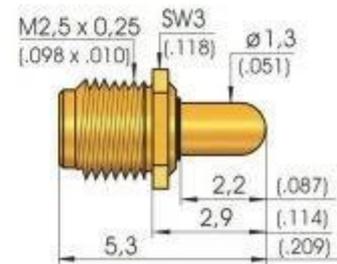
SFENG



SFENG



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nombre del producto	Sonda de prueba de fuerza de resorte de 200 g para prueba de PCB
Talla	50mil 75mil 100mil o pin personalizado
Ración actual	0-50A
Fuerza de la primavera	personalizado
Resistencia de contacto	50m Ω

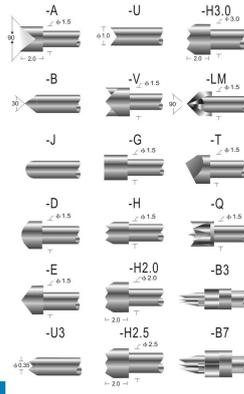
SF-P100



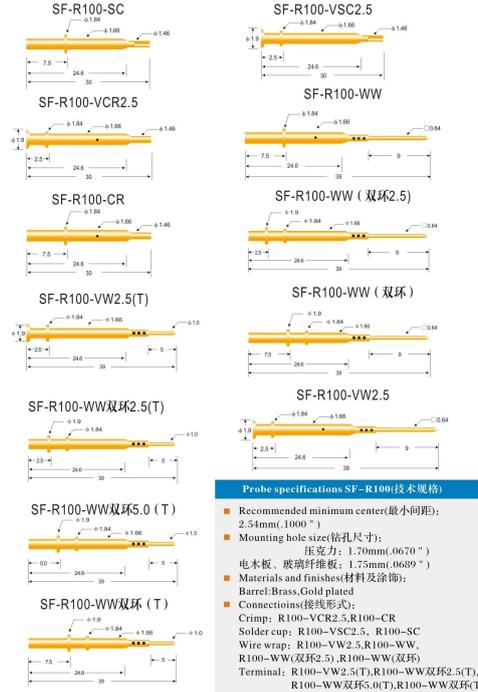
SF-P100-E

Probe specifications SF-P100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(1000°)
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670°) 电木板、玻璃纤维板: 1.75mm(.0689°)
- Full travel(行程): 6.40(.2520°)
- Spring force(弹簧压力): 200g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; SK4, Rh plated Barrel: Brass, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)



SF-R100



Probe specifications SF-R100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(1000°)
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670°) 电木板、玻璃纤维板: 1.75mm(.0689°)
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R100-VCR2.5, R100-CR Solder cup: R100-VSC2.5, R100-SC Wire wrap: R100-VW2.5, R100-WW, R100-WW(双环2.5), R100-WW(双环) Terminal: R100-VW2.5(T), R100-WW双环2.5(T), R100-WW双环5.0(T), R100-WW双环(T)

Producción Fluir



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products



6. Packing

Prueba Equipo



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

Embalaje y envío

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

